SONY

ILX569K

22 pin DIP (Plastic)

5340-pixel × 6 line CCD Linear Sensor (Color)

Description

The ILX569K is a reduction type CCD linear sensor developed for color image scanner. This sensor reads A4-size documents at a density of 600 DPI and 1200 DPI.

Sensor Line Features

• Number of effective pixels:

32040 pixels (5340 pixels \times 6)

Pixel size: 4μm × 4μm (4μm pitch)

• Distance between main line: 48µm (12 lines)

• Distance between main line and sub line: 8µm (2 lines)



Single-sided readout

Ultra low lag

• Single 12V power supply

Maximum data rate: 8MHz/Color
Input clock pulse: CMOS 5V drive

• Number of output: 3 (R, G, B)

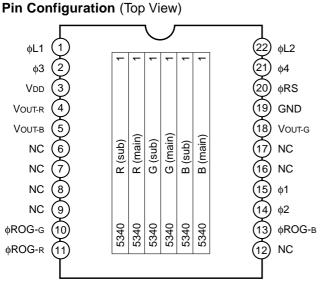
Package: 22 pin Plastic-DIP (400mil)

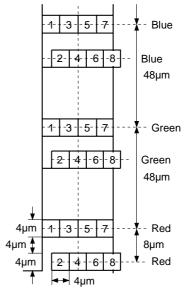
Absolute Maximum Ratings

• Supply voltage VDD 15 V

• Operating temperature —10 to +55 °C

Sensor Configuration





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Pin Description

Pin No.	Symbol	Description	Pin No.	Symbol	Description
1	φL1	Clock pulse input	12	NC	NC
2	ф3	Clock pulse input	13	фROG-в	Clock pulse input
3	VDD	12V power supply	14	φ2	Clock pulse input
4	Vout-r	Signal output (red)	15	φ1	Clock pulse input
5	Vоит-в	Signal output (blue)	16	NC	NC
6	NC	NC	17	NC	NC
eet41 <mark>7</mark> .coi	ⁿ NC	NC	18	Vоит-g	Signal output (green)
8	NC	NC	19	GND	GND
9	NC	NC	20	φRS	Clock pulse input
10	φ ROG -G	Clock pulse input	21	φ4	Clock pulse input
11	φROG-R	Clock pulse input	22	φL2	Clock pulse input

Recommended Supply Voltage

Item	Min.	Тур.	Max.	Unit
Vdd	11.4	12	12.6	V

Clock Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit
Input capacity of φ1, φ2	Сф1, Сф2	_	1500	_	pF
Input capacity of φRS	Cors	_	10	_	pF
Input capacity of φROG	Сфкоб	_	10	_	pF
Input capacity of \$\phi 3\$, \$\phi 4\$, \$\phi L1\$, \$\phi L2\$	Сф11, Сф12, Сф3, Сф4	_	20	_	pF

Clock Frequency

Item	Symbol	Min.	Тур.	Max.	Unit
φ1, φ2, φL1, φL2	fφ1, fφ2, fφL1, fφL2	_	0.5	8	MHz
φ3, φ4, φRS	fφ3, fφ4, fφRS	_	1	8	MHz

Input Clock Pulse Voltage Condition

Item	Min.	Тур.	Max.	Unit	
φ1, φ2, φRS, φROG,	High level	4.75	5.0	5.25	V
φL1, φL2, φ3, φ4 pulse voltage	Low level		0	0.1	V

Electrooptical Characteristics (Note 1)

(Ta = 25°C, VDD = 12V, fors = 1MHz, Input clock = 5Vp-p, Light source = 3200K, IR cut filter CM-500S (t = 1.0mm))

Item	Symbol	Min.	Тур.	Max.	Unit	Remarks		
	Red	RR	1.3	1.8	2.3			
Sensitivity	Green	Rg	1.2	1.7	2.2	V/(lx · s)	Note 2	
	Blue	Rв	0.8	1.2	1.6			
Sensitivity nonuniformity		PRNU	_	4	20	%	Note 3	
Saturation output voltage		Vsat	1.8	2.0	_	V	Note 4	
	Red	SER	_	1	_			
Saturation exposure	Green	SEG	_	1	_	lx · s	Note 5	
	Blue	SEB	_	1.64	_			
Dark voltage average	Dark voltage average		_	0.1	1.6	mV	Note 6	
Dark signal nonuniformity		DSNU	_	0.5	3.2	mV	Note 6	
Image lag	Image lag		_	0.02	_	%	Note 7	
Supply current		Ivdd	_	30	45	mA	Note 8	
Total transfer efficiency		TTE	92	98	_	%		
Output impedance	Zo	_	360	_	Ω			
Offset level		Vos		5.7	_	V	Note 9	

Notes:

- 1. In accordance with the given electrooptical characteristics, the black level of 1200 DPI is defined as the average value of D32, D33 to D73.
- 2. For the sensitivity test light is applied with a uniform intensity of illumination.
- 3. PRNU is defined as indicated below. Ray incidence conditions are the same as for Note 2. Vouτ = 500mV (typ.)

$$PRNU = \frac{(V_{MAX} - V_{MIN})/2}{V_{AVE}} \times 100 [\%]$$

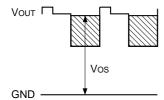
- 4. Use below the minimum value of the saturation output voltage.
- 5. Saturation exposure is defined as follows.

$$SE = \frac{V_{SAT}}{R}$$

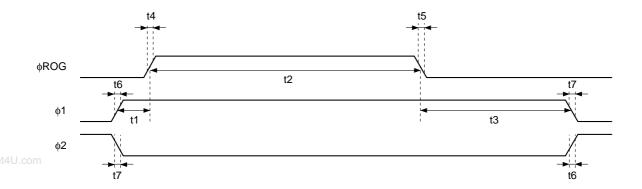
Where R indicates RR, Rg, RB and SE indicates SER, SEG, SEB.

- 6. Optical signal accumulated time τ int stands at 4ms.
- 7. Vout-g = 500mV (typ.)
- 8. Supply current means the total current of this device.
- 9. Vos is defined as indicated bellow.

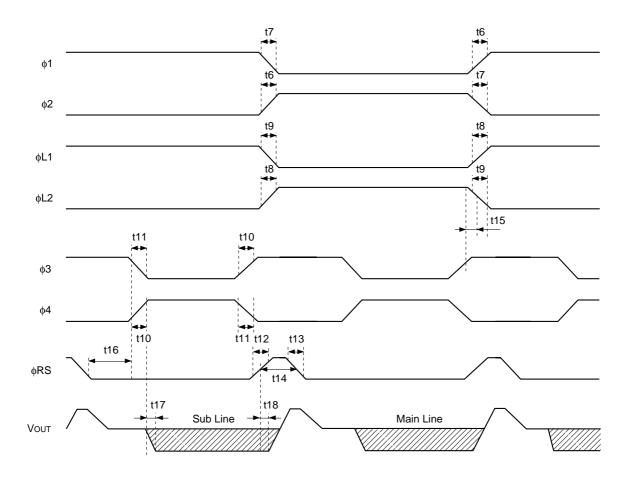
Vour indicates Vour-R, Vour-G, and Vour-B.



Clock Timing Chart 3



ClockTiming Chart 4

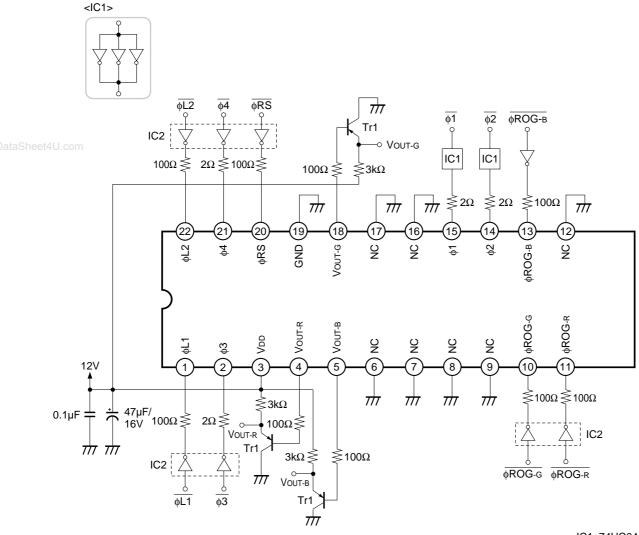


Clock Pulse Recommended Timing

Item	Symbol	Min.	Тур.	Max.	Unit
φROG, φ1 pulse timing	t1	50	100		ns
φROG pulse high level period	t2	5000	6000	_	ns
φROG pulse high level period	t3	1200	1500	_	ns
φROG pulse rise time	t4	0	5	10	ns
φROG pulse fall time	t5	0	5	10	ns
φ1 pulse rise time/φ2 pulse fall time	t6	0	50	80	ns
φ1 pulse fall time/φ2 pulse rise time	t7	0	50	80	ns
φL1 pulse rise time/φL2 pulse fall time	t8	0	10	30	ns
φL1 pulse fall time/φL2 pulse rise time	t9	0	10	30	ns
φ3 pulse rise time/φ4 pulse fall time	t10	0	10	30	ns
φ3 pulse fall time/φ4 pulse rise time	t11	0	10	30	ns
φRS pulse rise time	t12	0	10	30	ns
φRS pulse fall time	t13	0	10	30	ns
φRS pulse high level period	t14	60	120*1	_	ns
φL1, φL2 and φ3 pulse timing	t15	0	10	_	ns
φRS, φ3 pulse timing	t16	60	250*1		ns
Signal output dolay time	t17		40		ns
Signal output delay time	t18	_	20	_	ns

^{*1} These timing data is the recommended condition under $f\phi RS = 1 MHz$.

Application Circuit*1



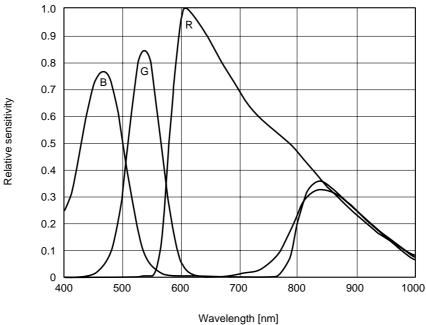
*1 Data rate fors = 1MHz

IC1: 74HC04 × 3pcs IC2: 74HC04 Tr1: 2SA1175

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Example of Representative Characteristics





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Notes on Handling

1. Static charge prevention

CCD image sensors are easily damaged by static discharge. Before handling be sure to take the following protective measures.

- a) Either handle bare handed or use non-chargeable gloves, clothes or material. Also use conductive shoes.
- b) When handling directly use an earth band.
- c) Install a conductive mat on the floor or working table to prevent the generation of static electricity.
- d) Ionized air is recommended for discharge when handling CCD image sensors.
- e) For the shipment of mounted substrates, use boxes treated for the prevention of static charges.

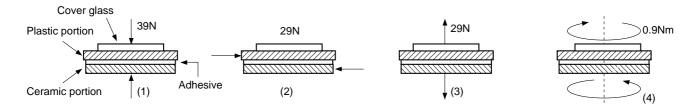
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2. Notes on handling CCD packages

The following points should be observed when handling and installing packages.

- a) Remain within the following limits when applying a static load to the package.
 - (1) Compressive strength: 39N/surface (Do not apply load more than 0.7mm inside the outer perimeter of the glass portion.)

(2) Shearing strength: 29N/surface(3) Tensile strength: 29N/surface(4) Torsional strength: 0.9Nm



- b) In addition, if a load is applied to the entire surface by a hard component, bending stress may be generated and the package may fracture, etc., depending on the flatness of the ceramic portion. Therefore, for installation, either use an elastic load, such as a spring plate, or an adhesive.
- c) Be aware that any of the following can cause the packege to crack or dust to be generated.
 - (1) Applying repetitive bending stress to the external leads.
 - (2) Applying heat to the external leads for an extended period of time with soldering iron.
 - (3) Rapid cooling or heating.
 - (4) Prying the plastic portion and ceramic portion away at a support point of the adhesive layer.
 - (5) Applying the metal a crash or a rub against the plastic portion.

Note that the preceding notes should also be observed when removing a component from a board after it has already been soldered.

3. Soldering

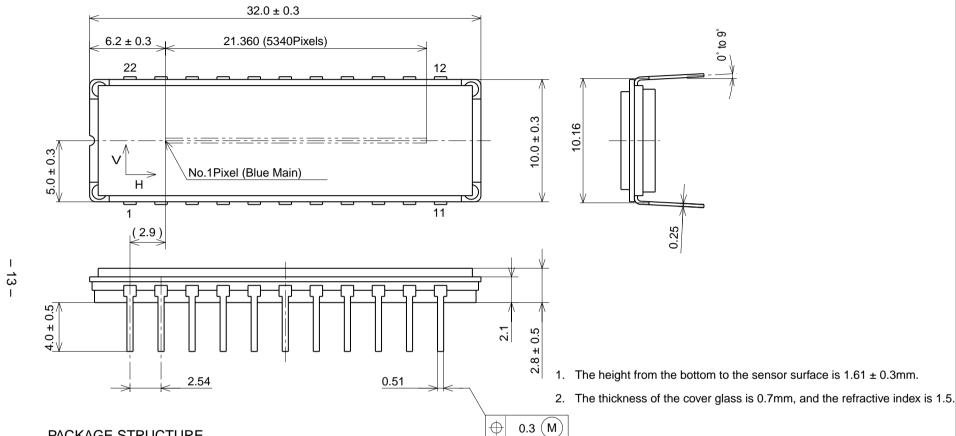
- a) Make sure the package temperature does not exceed 80°C.
- b) Solder dipping in a mounting furnance causes damage to the glass and other defects. Use a grounded 30W soldering iron and solder each pin in less than 2 seconds. For repairs and remount, cool sufficiently.
- c) To dismount an image device, do not use a solder suction equipment. When using an electric desoldering tool, ground the controller. For the control system, use a zero-cross type.

- 4. Dust and dirt protection
 - a) Operate in clean environments.
 - b) Do not either touch glass plates by hand or have any object come in contact with glass surfaces. Should dirt stick to a glass surface, blow it off with an air blower. (For dirt stuck through static electricity ionized air is recommended.)
 - c) Clean with a cotton bud and ethyl alcohol if the glass surface is grease stained. Be careful not to scratch the glass.
 - d) Keep in a case to protect from dust and dirt. To prevent dew condensation, preheat or precool when moving to a room with great temperature differences.
- www.DataShe 5.4 Exposure to high temperatures or humidity will affect the characteristics. Accordingly avoid storage or usage in such conditions.
 - 6. CCD image sensors are precise optical equipment that should not be subject to mechanical shocks.

Package Outline

Unit: mm

22pin DIP (400mil)



PACKAGE STRUCTURE

PACKAGE MATERIAL	Plastic,Ceramic
LEAD TREATMENT	GOLD PLATING
LEAD MATERIAL	42 ALLOY
PACKAGE MASS	2.21g
DRAWING NUMBER	LS-D18(E)

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